LITEON SEMICONDUCTOR

SUPER FAST GLASS PASSIVATED RECTIFIERS

FEATURES

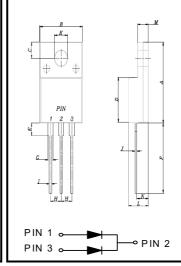
- · Glass passivated chip
- Superfast switching time for high efficiency
- · Low forward voltage drop and high current capability
- Low reverse leakage current
- High surge capacity
- Qualification is according to AEC-Q101 Rev_D

APPLICATION

- · Switched mode Power supplies
- High frequency DC to DC converters

MECHANICAL DATA

- Case: JEDEC TO-220ABFP
- Case Material: "Green" molding compound, UL flammability classification 94V-0, "Halogen-free".
- Lead free finish, RoHS compliant
- Weight: 1.558 grams (Approximate)
- Marking code: STPF1040CTSW



STPF1040CTSW

REVERSE VOLTAGE – 400 Volts FORWARD CURRENT – 10 Amperes

ITO-220(S)AB



REV-2 ,Sep-2019, KTGC82

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

ABSOLUTE RATINGS

PAR	PARAMETER		SYMBOL	VALUE		UNIT
Maximum repetitive peak reverse	e voltage		V _{RRM}	40	0	V
Maximum DC blocking voltage			V _{DC}	40	0	V
Maximum Average rectified output current		@Tc=105°C	I _(AV)	10		A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load.		vave	IFSM	80		A
Operating junction and Storage	Femperature range		Tj, Tstg	-55 ~ +150		°C
STATIC ELECTRICAL CI	HARACTERIST	ICS				
PARAMETER	TEST C	TEST CONDITIONS		ТҮР	MAX	UNIT
Forward voltage (Note1)	I⊧=5A	T」=25°C T」=125°C	VE	 0.94	1.30 1.20	V
	I _F =10A	TJ=25°C TJ=125°C	VF	 1.10	1.50 1.40	
Leakage current	V _R =400V	TJ=25°C TJ=100°C	IR	 1.95	10 250	uA
Typical junction capacitance (No	te 2)		CJ	2	27	
DYNAMIC ELECTRICAL	CHARACTERI	STICS	li l			
PARAMETER	TEST C	TEST CONDITIONS		MAX		UNIT
Reverse recovery time	I _F =0.5A, I _R =*	I _F =0.5A, I _R =1.0A, I _{RR} =0.25A		35		nS
THERMAL CHARACTER	ISTICS					
PARAMETER		SYMBOL	ТҮР		UNIT	

PARAMETER	SYMBOL	ТҮР	UNIT	
Typical thermal resistance (Note 3,4)	RthJc	4	°C/W	
Typical thermal resistance (Note 3,4)	RthJ∟	4		

Note :

(1) 300us pulse width, 2% duty cycle.

(2) Measured at 1.0MHz and applied voltage of 4.0V DC.

(3) Thermal resistance test performed in accordance with JESD-51.

(4) The unit mounted on Aluminum plate 29.6mm x 23.9mm x 1.87mm and copper heatsink 100mm x 100mm x 1.9mm

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RATING AND CHARACTERISTIC CURVES STPF1040CTSW

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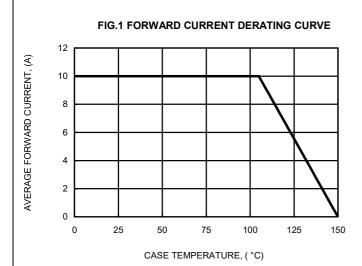
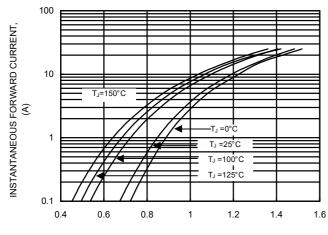


FIG.3 TYPICAL FORWARD CHARACTERISTICS



INSTANTANEOUS FORWARD VOLTAGE, (V)

100 T. =150°C INSTANTANEOUS REVERSE CURRENT, (uA) 10 =125°C 1 T_J =100°C 0.1 T_J =25°C 0.01 0.001 T_J =0°C 0.0001 0 40 80 120 160 200 240 280 320 360 400 440 RATED PEAK REVERSE VOLTAGE, (V)

FIG.2 MAXIMUM NON-REPETITIVE SURGE CURRENT

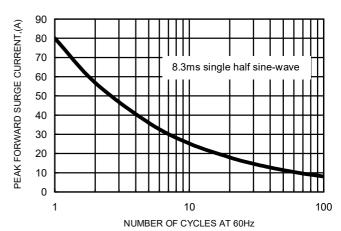


FIG.4 TYPICAL JUNCTION CAPACITANCE

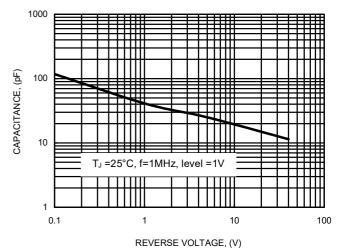


FIG.5 TYPICAL REVERSE CHARACTERISTICS



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